

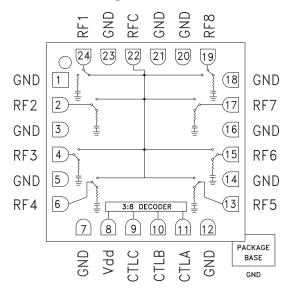


Typical Applications

The HMC253LC4 is ideal for:

- · Basestations & Repeaters
- WiMAX/WiBro & Fixed Wireless
- Cellular/3G Infrastructure
- CATV/DBS
- Military & Hi-Rel

Functional Diagram



Features

Ceramic, RoHS Compliant 4x4mm SMT Package

Non-Reflective Topology Low Insertion Loss: 1.2 dB

Single Positive Supply: Vdd = +5V

Integrated 3:8 TTL/CMOS Decoder: 0/+3V

General Description

The HMC253LC4 is a non-reflective SP8T switch in a leadless RoHS compliant 4x4 mm ceramic SMT package featuring wideband operation from DC to 3.5 GHz. The switch offers a single positive bias and true TTL/CMOS compatibility enabling it to operate with 0/+3V control and a +5V supply. A 3:8 decoder is integrated on the switch requiring only 3 control lines and a positive bias to select each path. The HMC253LC4 SP8T will replace multiple configurations of SP4T and SPDT MMIC switches.

Electrical Specifications,

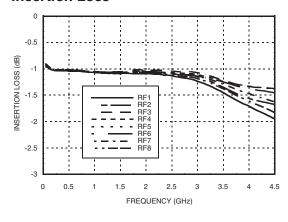
$T_A = +25^{\circ}$ C, For TTL Control and Vdd = +5V in a 50 Ohm system

Parameter		Frequency	Min.	Тур.	Max.	Units
Insertion Loss		DC - 2.0 GHz DC - 3.0 GHz DC - 3.5 GHz		1.1 1.2 1.3	1.5 1.6 1.7	dB dB dB
Isolation		DC - 2.0 GHz DC - 3.0 GHz DC - 3.5 GHz	35 31 30	40 36 35		dB dB dB
Return Loss	"On State"	0.3 - 3.0 GHz 0.3 - 3.5 GHz	15 12	18 14		dB dB
Return Loss (RF1-8)	"Off State"	0.3 - 3.5 GHz 0.5 - 3.5 GHz	7 10	10 14		dB dB
Input Power for 1 dB Compression		0.5 - 3.5 GHz	20	24		dBm
Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone)		0.5 - 3.5 GHz	40	43		dBm
Switching Characteristics		0.3 - 3.5 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)				30 100		ns ns

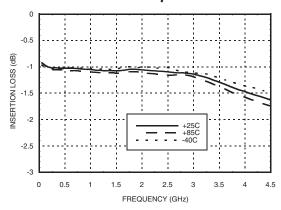




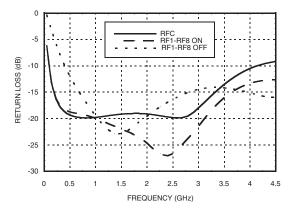
Insertion Loss



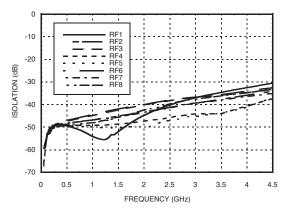
Insertion Loss vs. Temperature



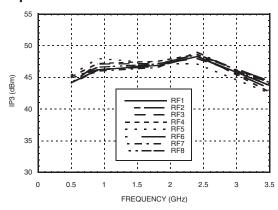
Return Loss



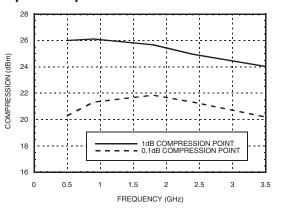
Isolation



Input IP3



Input Compression







Bias Voltage & Current

Vdd Range = +5.0 Vdc ± 10%			
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)	
+5.0	6.0	9.0	

TTL/CMOS Control Voltages

State	Bias Condition	
Low	0 to +0.8 Vdc @ 5 uA Typ.	
High	+2.0 to +5.0 Vdc @ 70 uA Typ.	

Truth Table

Control Input			Signal Path State		
А	В	С	RFCOM to:		
Low	Low	Low	RF1		
High	Low	Low	RF2		
Low	High	Low	RF3		
High	High	Low	RF4		
Low	Low	High	RF5		
High	Low	High	RF6		
Low	High	High	RF7		
High	High	High	RF8		

DC Blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8.

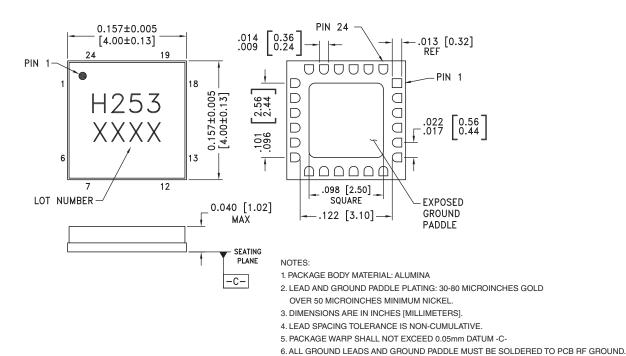
Absolute Maximum Ratings

Bias Voltage Range (Port Vdd)	+7.0 Vdc		
Control Voltage Range (A, B, C)	-0.5V to Vdd +1Vdc		
Channel Temperature	150 °C		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		
Maximum Input Power Vdd = +5V	+20 dBm (0.05 - 0.5 GHz) +25 dBm (0.5 - 3.5 GHz)		



Outline Drawing

BOTTOM VIEW

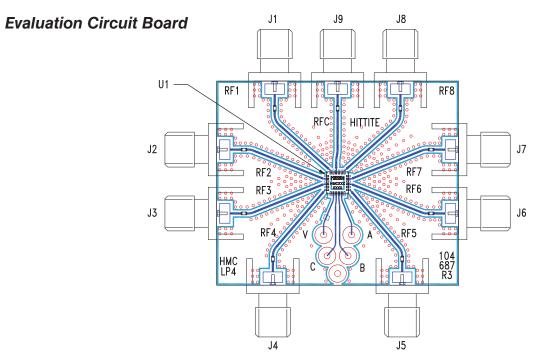






Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 5, 7, 12, 14, 16, 18, 20, 21, 23	GND	Package bottom has exposed metal paddle that must also be connected to RF ground.	= O GND
2, 4, 6, 13, 15, 17, 19, 22, 24	RF1 - RF8 & RFC	This pin is DC coupled and matched to 50 Ohms. Blocking capacitors are required.	
8	Vdd	Supply Voltage +5.0 Vdc ±10%	Vdd 0
9	CTLC		Vdd
10	CTLB	See truth table and control voltage table.	
11	CTLA		<u> </u>



List of Materials for Evaluation PCB 107780 [1]

Item	Description	
J1 - J9	PCB Mount SMA Connector	
J10 - J14	DC Pin	
C1 - C9	100 pF Capacitor, 0402 Pkg.	
C10	0.01 uF Capacitor, 0603 Pkg.	
U1	HMC253LC4 SP8T Switch	
PCB [2]	104687 Eval Board	

^[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF ports should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown above. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.